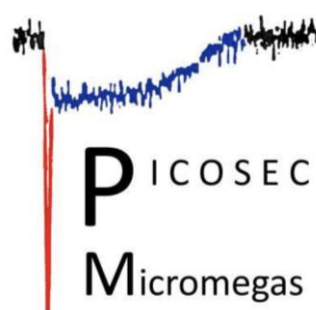




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Jefferson Lab



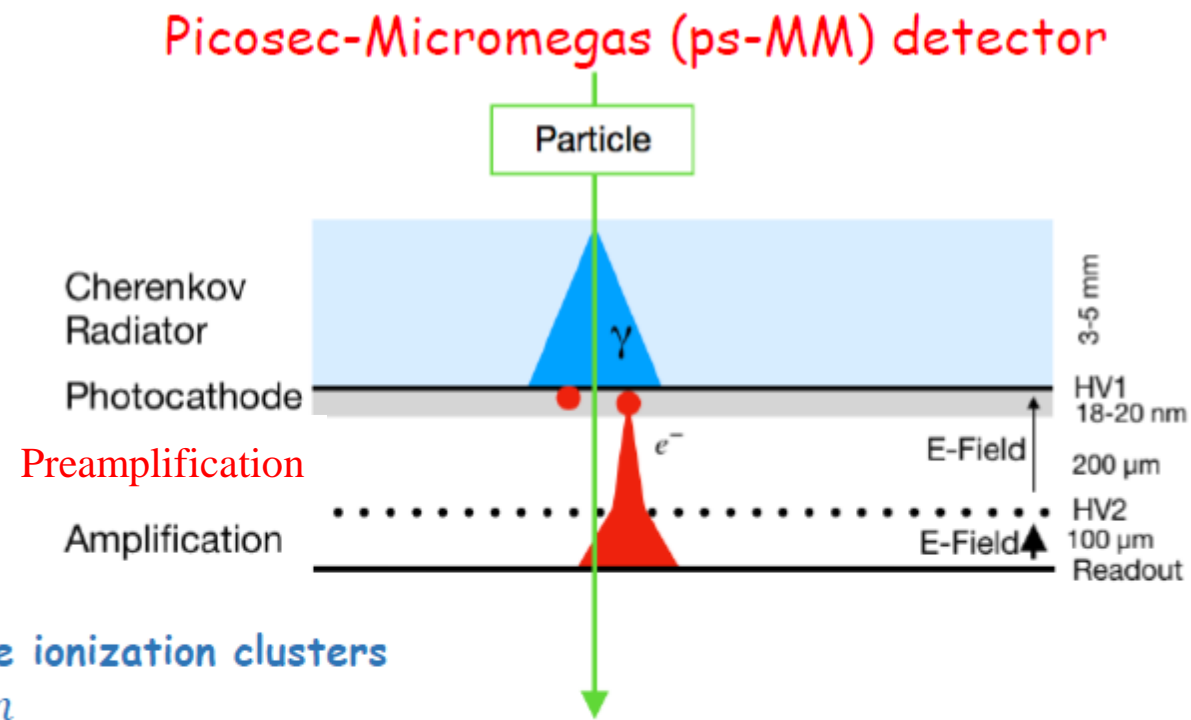
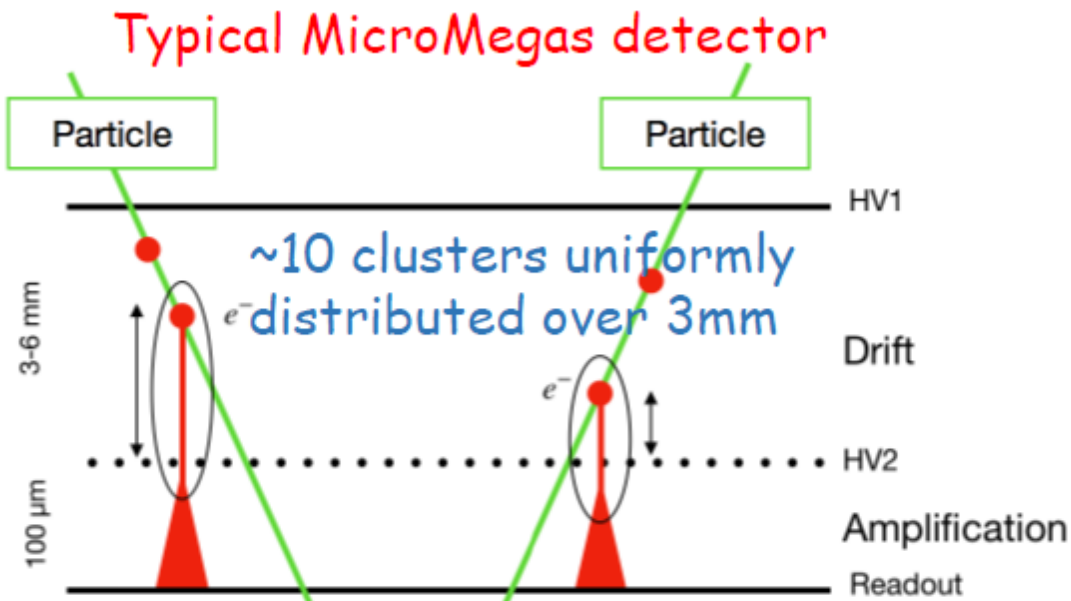
μ RWELL-PICOSEC: Fast timing detector with μ RWELL gaseous amplification technology

Kondo Gnanvo

on behalf PICOSEC collaboration

Radiation Detectors & Imaging Group (RD&I Group), Jefferson Lab, Virginia

- ❖ Concept of MPGD-based picosecond timing & the PICOSEC collaboration.
- ❖ The μ RWELL-PICOSEC Detector.
- ❖ Preliminary results from beam tests
- ❖ Summary & Plans for future R&D



Time jitter due to multiple ionization clusters

$$\sigma_t = \frac{\sigma_1}{v_e} \sim \frac{300 \mu\text{m}}{50 \frac{\text{mm}}{\mu\text{s}}} = 6 \text{ ns}$$

The time resolution is mainly limited to the direct initial ionization in the drifting zone:

- ◆ Uncertain of the collision position
- ◆ Small velocity of electrons
- ◆ Spread of electrons during the drifting progress



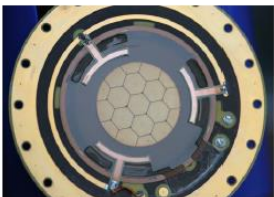

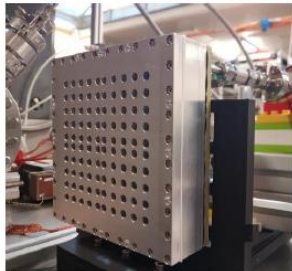

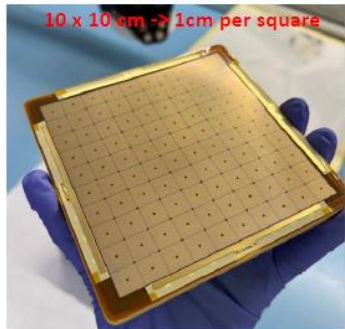
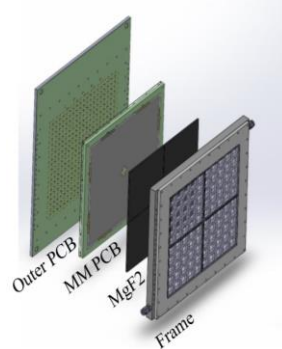
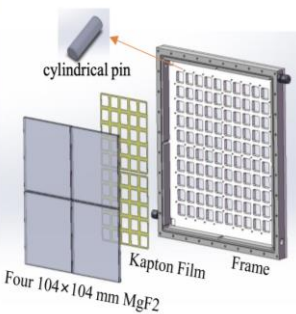
Novel fast time Micromegas detectors:

- ◆ Reducing the directly initial ionization by reducing the length of drifting zone
- ◆ Increasing the electric field
- ◆ Cerenkov Radiator and Photocathode produce photoelectrons, small longitudinal diffusion

Courtesy Xu Wang, MPGD-China 2017

PICOSEC Coll.: Development of fast timing (picosecond resolution) MPGD based on **Micromegas** technology (**MM-PICOSEC**)

- ❖ Large collaboration based at CERN with several major institutions from Europe, Asia and US (JLab, SBU ...)
- ❖ Proof of principle of picosecond timing with MPGD has been established with several generations of MM-PICOSEC prototypes:
- ❖ Large-area (10 cm × 10 cm) and multi-channel (100 pads) prototype → **< 20 ps** with MIPs and **~50 ps** with single photon (laser)
- ❖ R&D on PICOSEC technologies is part of DRD1 WP7 → strong connection (i.e., beam test campaign and GDD lab at CERN)

								
<ul style="list-style-type: none"> • 1-ch (φ1cm) • Proof of concept • Resistive and non-resistive prototypes. 	<ul style="list-style-type: none"> • 7-ch (1cm) • Signal sharing • Resistive prototype 	<ul style="list-style-type: none"> • 19-ch (φ3.6cm) • Signal sharing. 	<ul style="list-style-type: none"> • 100-ch (10 cm x10 cm) • Tileable • Hybrid ceramic substrate MM • MM decoupled from housing with spring-loaded pins 	<ul style="list-style-type: none"> • 100 ch (10 cm x10 cm) • MgF2 mechanically decoupled 	<ul style="list-style-type: none"> • 100 ch (10 cm x10 cm) • Sealed Ti housing • Increased fill factor 	<p>10 x 10 cm → 1cm per square</p>	<p>Outer PCB MM PCB MgF2 Frame</p>	<p>cylindrical pin Kapton Film Frame Four 104x104 mm MgF2</p>

20x20 Resistive PICOSEC MM from USTC

- Bortfeldt *et al.*, Nuclear Inst. and Methods in Physics Research, A 903 (2018) 317–325, <https://doi.org/10.1016/j.nima.2018.04.033>
- Aune *et al.*, Nuclear Inst. and Methods in Physics Research, A 993 (2021) 165076, <https://doi.org/10.1016/j.nima.2021.165076>
- A. Utrobicic *et al.*, 2023 JINST 18 C07012, <https://doi.org/10.1088/1748-0221/18/07/C07012>
- Y. Meng, USTC, MPGD2024

AUTH (Greece) I. Angelis, K. Kordas, C. Lampoudis, I. Maniatis, I. Manthos, K. Paraschou, D. Sampsonidis, A. Tsiamis, S. E. Tzamarias

CEA-IRFU, LIST, LIDYL(France) S. Aune, D. Desforge, I. Giomataris, T. Gustavsson, F. Jeanneau, A. Kallitsopoulou, M. Kebbiri, P. Legou, T. Papaevangelou, M. Pomorski, E. Scorsonne

CERN (Switzerland) J. Bortfeldt, F. Brunbauer, C. David, D. Janssens, K.J. Floethner, M. Lupberger, M. Lisowska, H. Müller, E. Oliveri, G. Orlandini, F. Resnati, L. Ropelewski, L. Scharenberg, T. Schneider, M. van Stenis, R. Veenhof

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Ruder Boškovic Institute(Croatia) : A. Utrobicic

Stony Brook University (USA) J.Datta

USTC (Hefei, China) J. Liu, Y. Meng, X. Wang, Z. Zhang, Y. Zhou

University of Zagreb(Croatia) M. Kovacic,

University of Pavia (Italy) D. Fiorina, M. Brunoldi

Univeristy of Virginia (USA) S. White



μ RWELL-PICOSEC:

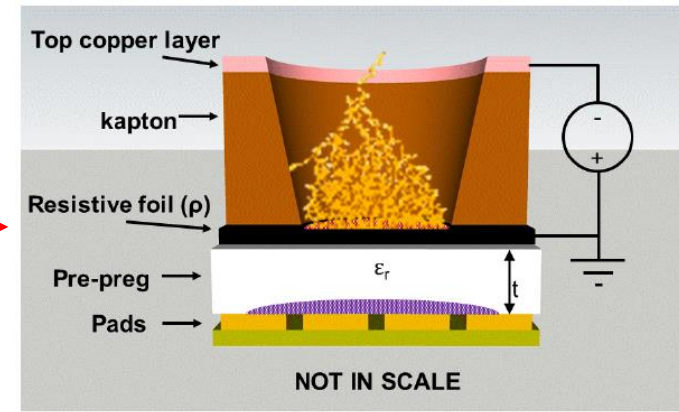
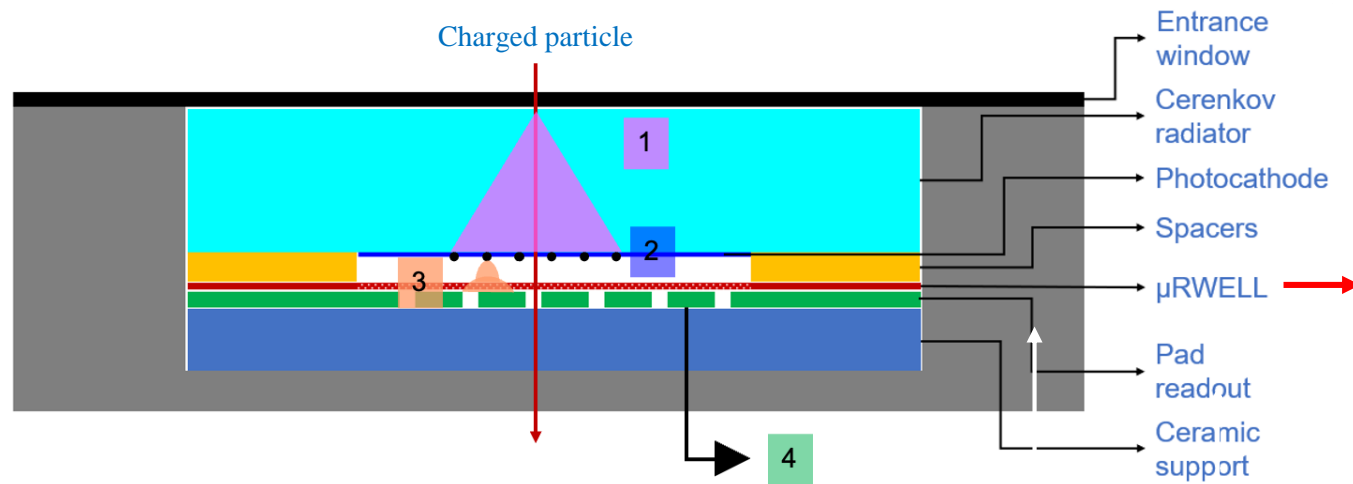
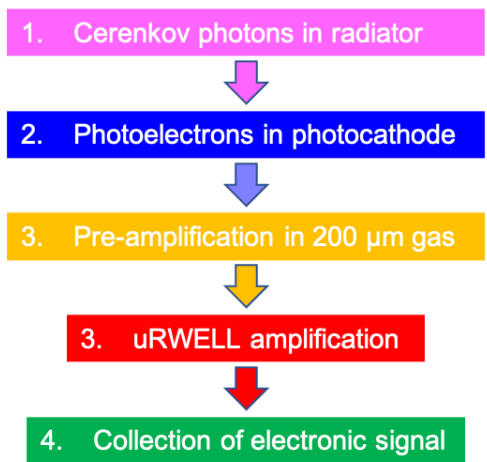
- ❖ Is an alternative MM-PICOSEC with strong synergies btw the two μ RWELL and Micromegas technologies
- ❖ The R&D effort started as the Jefferson Lab Laboratory Directed Research and Development (LDRD) Program in 2023
- ❖ Development of μ RWELL-PICOSEC technologies is included in the CPAD RDC6 as well as CERN DRD1 WP7 (Timing Detectors).

Potential applications for future HEP and NP experiments:

- ❖ μ RWELL-PICOSEC is attractive for Time-Of-Fight (TOF) detectors of charged particles and photosensors readout for RICH detectors.
- ❖ The technology could be used in future Electron Ion Collider (EIC) Detector II, ePIC upgrade or future experiments at Jefferson Lab
- ❖ Potential application in medical instrumentation such as for TOF-PET devices will be explored.

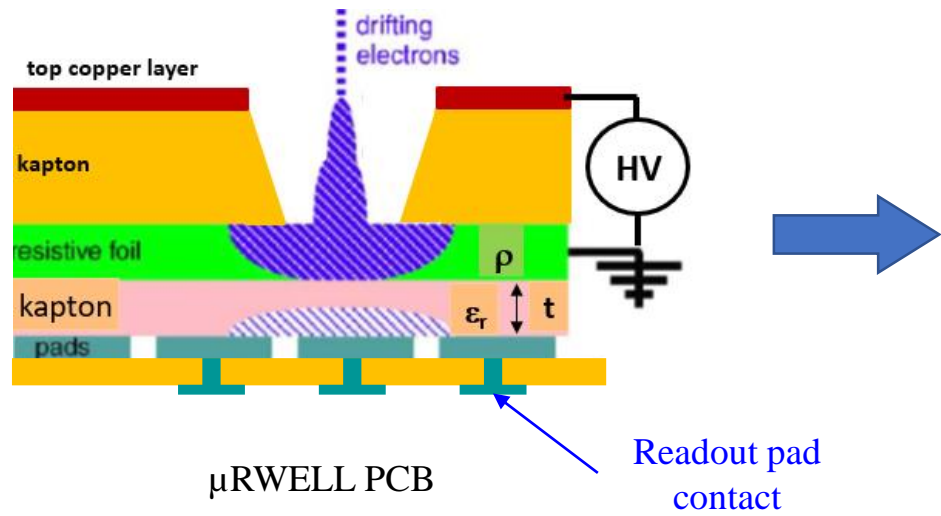
Concept of μRPICOSEC: fast timing gaseous detector using μRWELL amplification → time resolution of ~10s ps

1. **Cherenkov photons:** relativistic charged particle creates Cerenkov photons → prompt photons i.e. good timing.
2. **Photoelectrons:** convert the Cerenkov photons into electrons, all created at the location → good timing
3. **Pre-amplification:** First amplification of electrons ~100 μm gas in high drift field region (~20 kV/cm)
4. **Amplification:** Final electron amplification in μRWELL gain structure → high electric field (~40 kV/cm)
5. **Electronic Signal:** Arrival of the amplified electrons to the anode creates a signal.

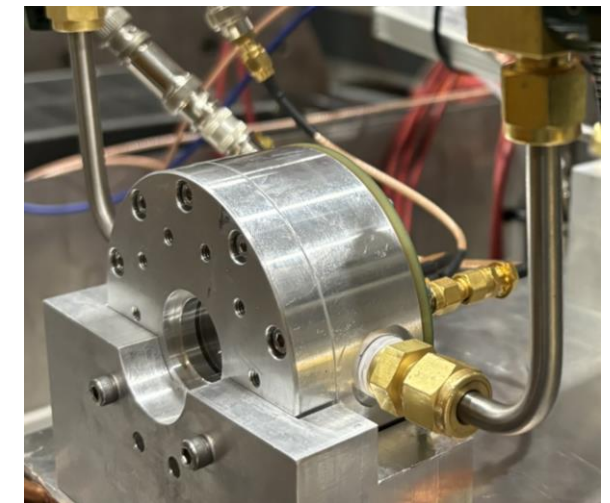


μRWELL PCB

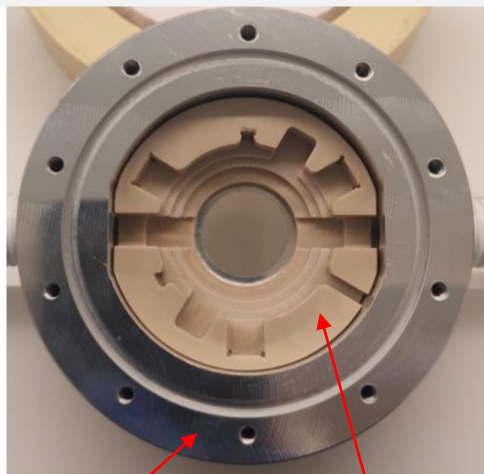
Typical gas mixture for Gaseous PICOSEC Neon : C₂H₆ : CF₄ = 80 : 10 : 10 (at ambient pressure)



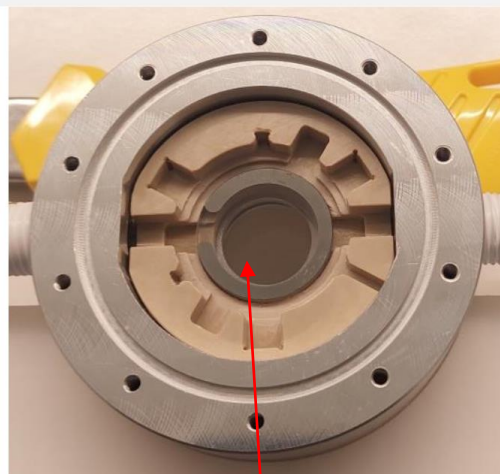
μ RWELL PCB front side



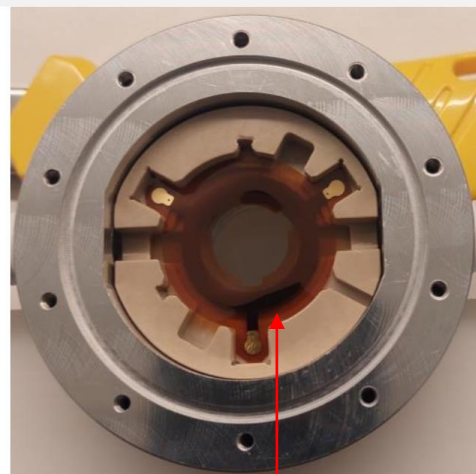
Prototype in Al chamber



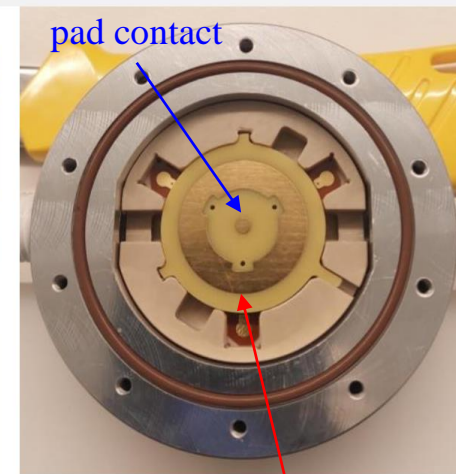
Al chamber PEEK insert



3mm MgF_2 crystal with 18nm CsI / 2nm DLC photocathode



Spacer / cathode contact



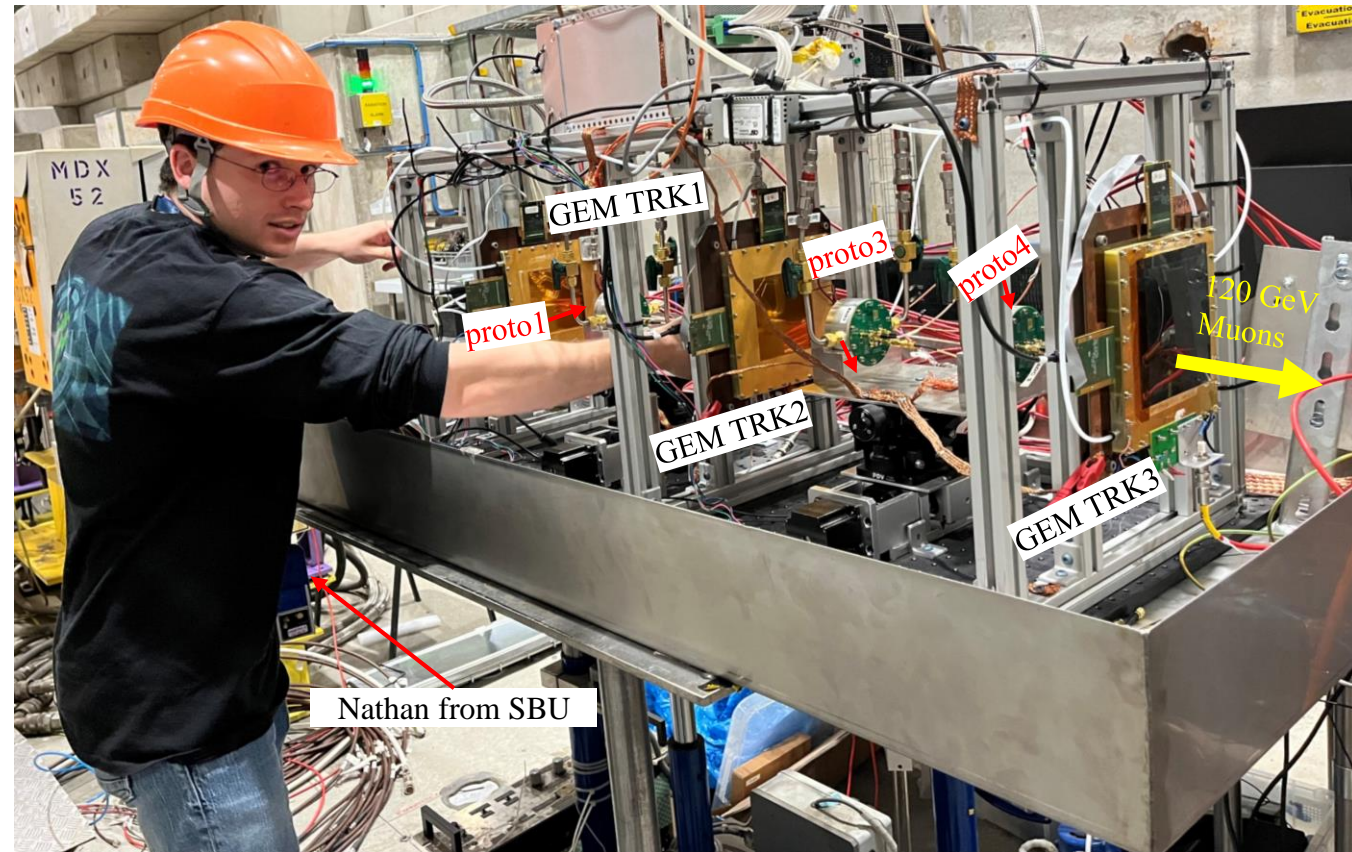
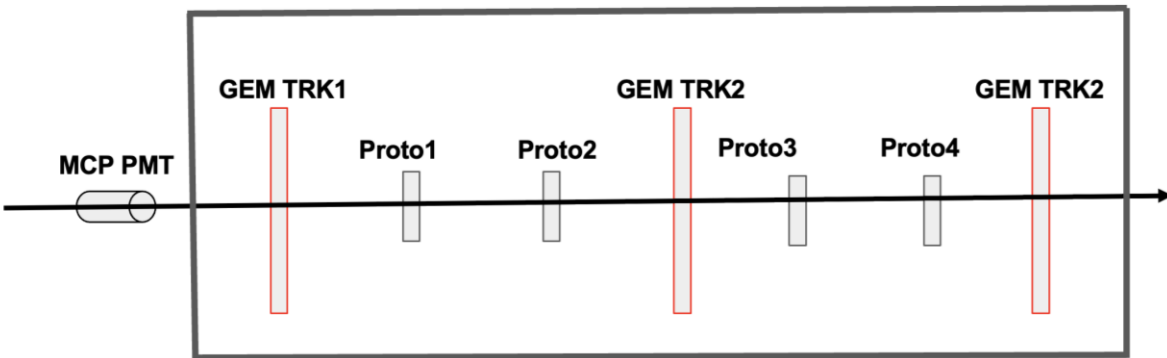
μ RWELL PCB back side



Outer board

The setup of small prototypes at the Summer 2024 :CERN beam test is a telescope composed of:

- ❖ **Prototypes:** 4 single-pad μ RWELL-PICOSEC
- ❖ **Reference timing detector:** MCP-PMT ~ 4 ps resolution
- ❖ **Tracking:** 3 triple-GEMs + APV25-SRS ~ 70 μ m
- ❖ **Preamplifier:** CIVIDEC or fast custom preamplifier
- ❖ **DAQ / readout:** high resolution oscilloscope

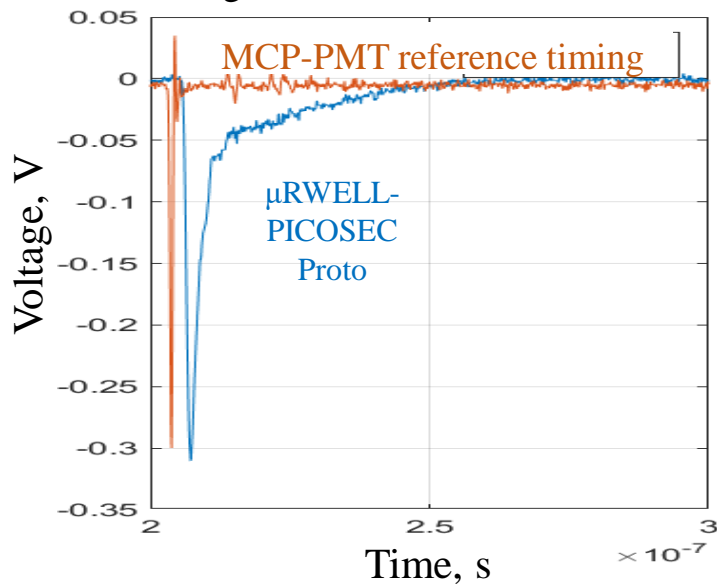


μ RWELL-PICOSEC Telescope used in April and July 2024 test beam at CERN

Several small prototypes with different characteristics and parameters were tested on this setup

- ❖ μ RWELL holes parameter (pitch, diameter, shapes) \rightarrow studies impact of geometry
- ❖ Thickness of the prepreg layer between μ RWELL and pd layer and pad geometry \rightarrow impact of detector capacitance
- ❖ Photocathode materials (CsI and DLC)

MCP-PMT & μ RWELL-PICOSEC signals with 150 GeV/c muons.



$$\text{Time difference} = (t_{\text{proto}} - t_{\text{ref}}) - t_{\text{walk}}$$

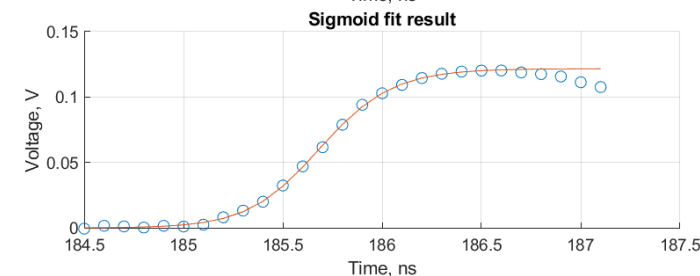
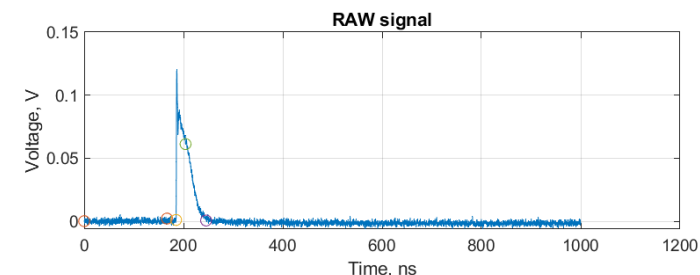
Time resolution of MCP PMT ~4ps

t_{ref} = Time of MCP PMT

t_{proto} = Time of μ RWELL-PICOSEC

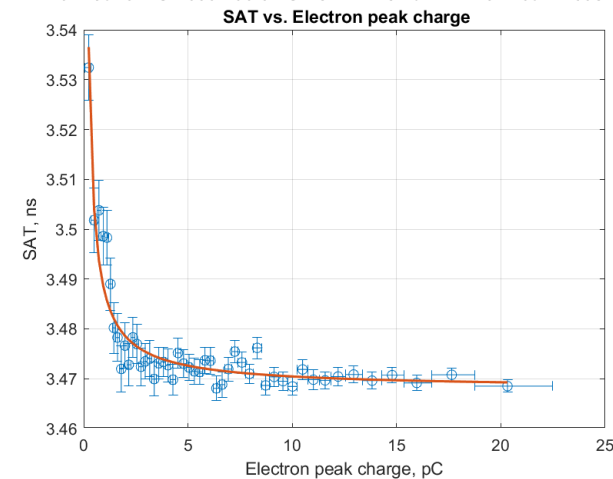
→ Constant Fraction (CF) analysis

- ❖ A sigmoid function is fitted to the leading edge of the electron-peak to minimize noise contribution
- ❖ The time corresponding to a 20% CF method applied to the sigmoid fit
- ❖ Time walk correction is applied before subtracting from the reference time
- ❖ Cuts used to obtained final time difference distribution:

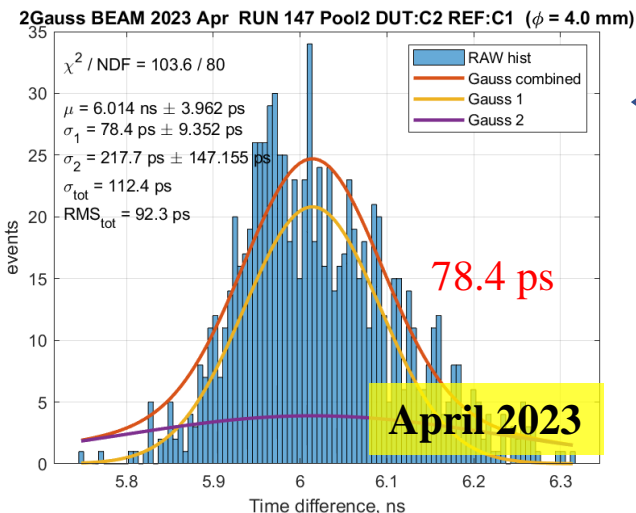


Sigmoid fit of signal

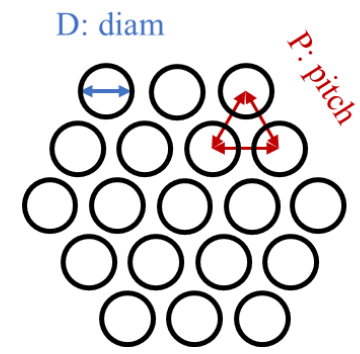
3EAM 2024 June RUN 036 Pool5 DUT:C4 REF:C1 μ RWELL9-170um-460C-255A-C



t_{walk} = Time walk correction



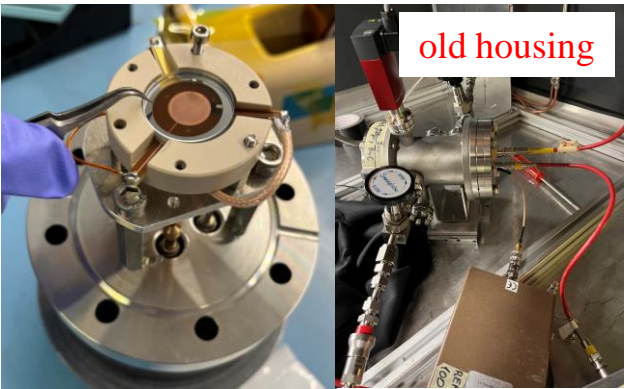
Standard μRWELL: Pitch 140 μm, outer diam 70 μm, inner diam. 50 μm



- New Alu housing
- New prototype Pitch 120 μm, outer diam 100 μm, inner diam. 80 μm

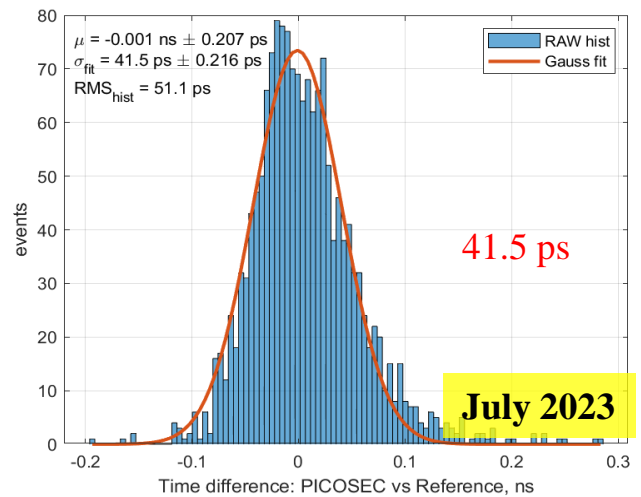


Std μRWELL proto – old housing



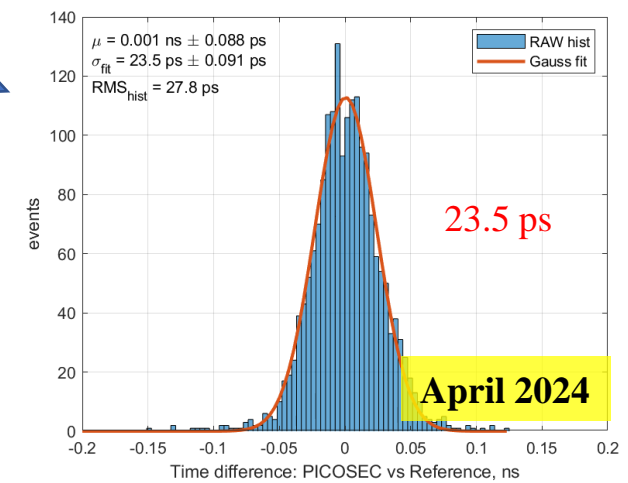
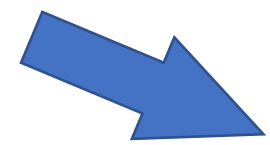
old housing

Old detector housing with wire connection to electrodes → increase capacitance



New μRWELL proto – old housing

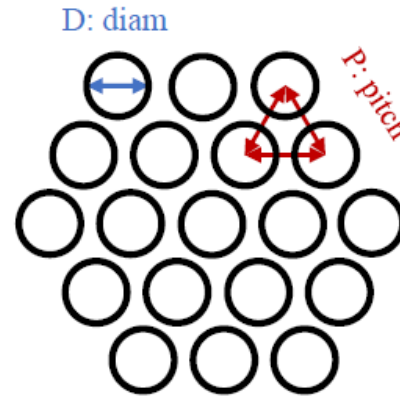
- New round of prototypes - different μRWELL geometries → change pitch and diameter
- Best result: Pitch 120 μm, outer diam 85 μm, inner diam. 65 μm



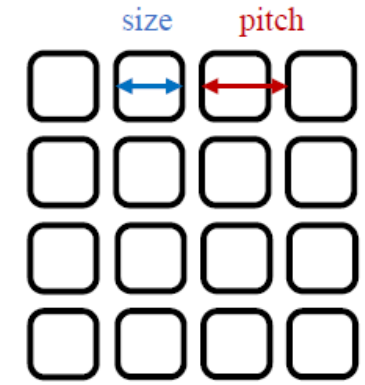
Newer μRWELL proto – new housing

Study the impact of μ RWELL hole geometry on timing

- ❖ In general, round hole geometry shows improved timing resolution (25.2 ps vs. 28 ps) for 3 μ RWELL HV settings (245V, 250V, 255V)
- ❖ For the lowest μ RWELL HV setting (240V), hole prototype is slightly better at 29 ps compared to 33 ps for the round



Round hole

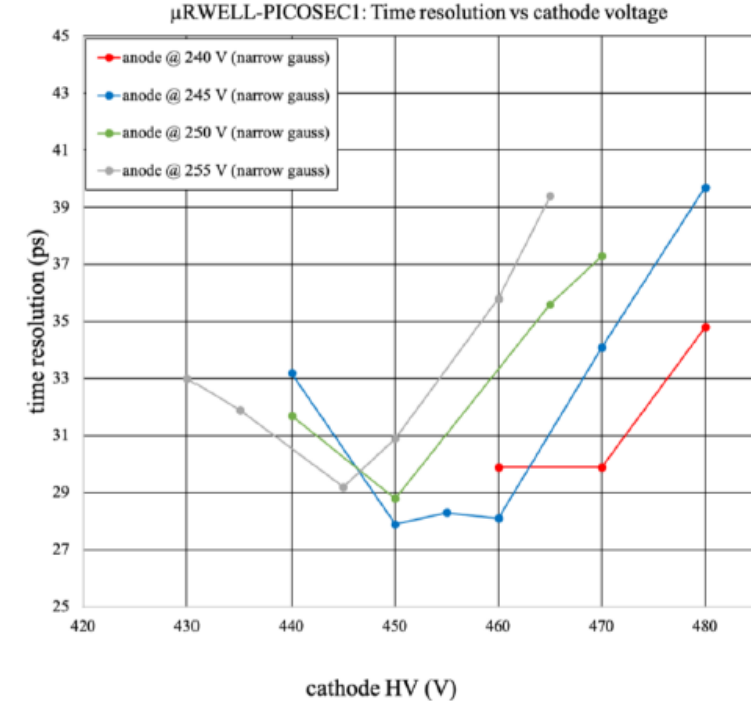
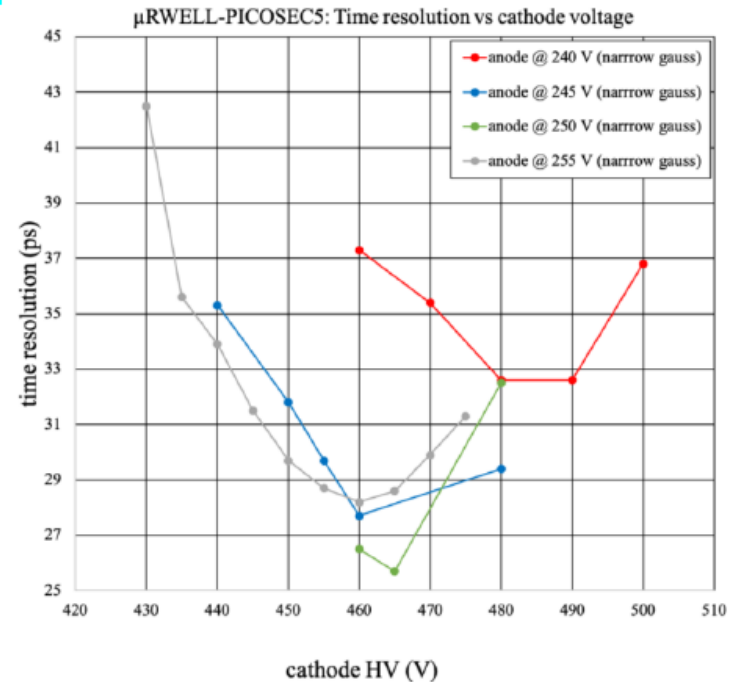


Square hole

Caveat: Different photocathode samples were used in different prototypes so the results might also be affected by the quality of the photocathode

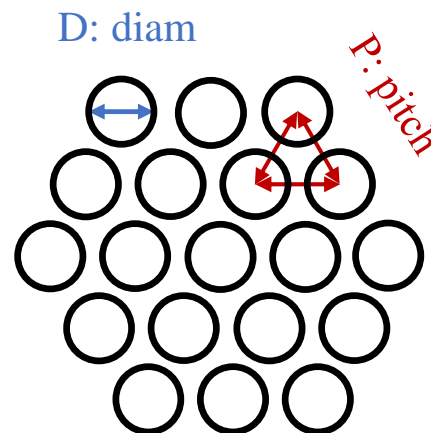
Hole geometries

Parameters	μ RWELL5	μ RWELL1
Pitch (μm)	120	120
Hole(o) (μm)	100	100
Hole(i) (μm)	80	80
Hole shape	Round	Square
Readout	Plain	Plain
Spacer (μm)	170	170
Photocathode	CsI	CsI

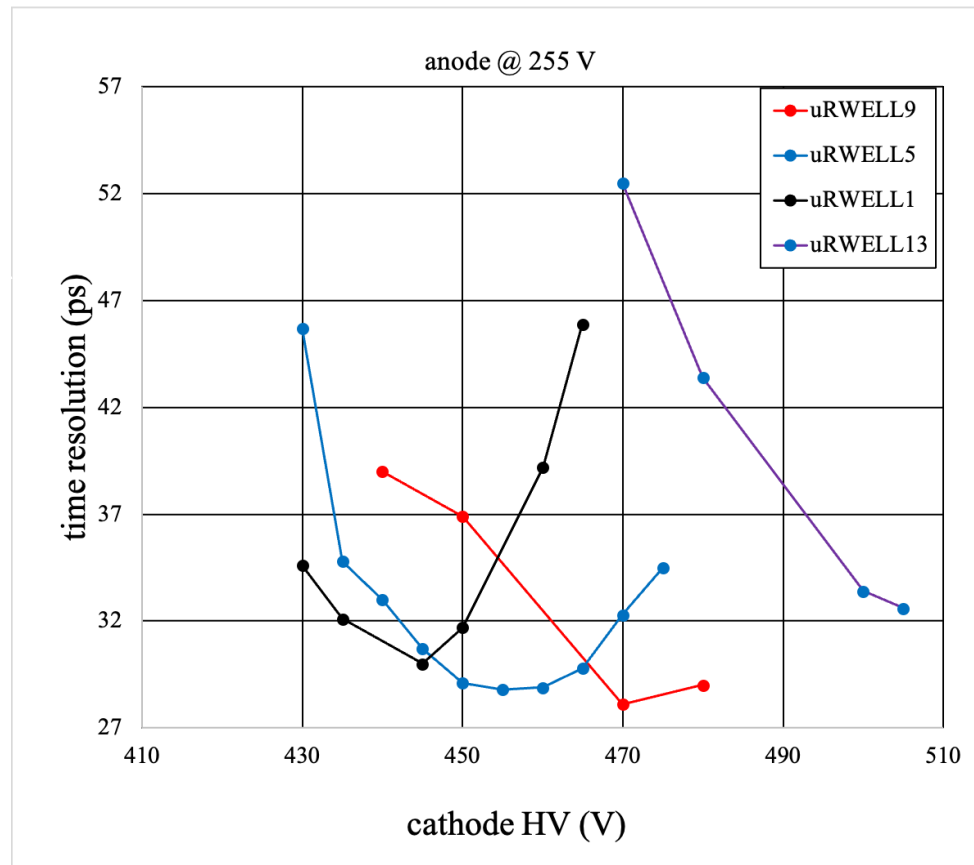


Study the impact of μ RWELL hole pitch on timing

- ❖ Best performance with μ RWELL9 (100 μ m pitch and 80 μ m hole diameter)
- ❖ Larger pitch μ RWELL5 and smaller pitch μ RWELL13 gives slightly worst timing but more data needed for definite conclusion



Caveat: Different photocathode samples were used in different prototypes so the results might also be affected by the quality of the photocathode



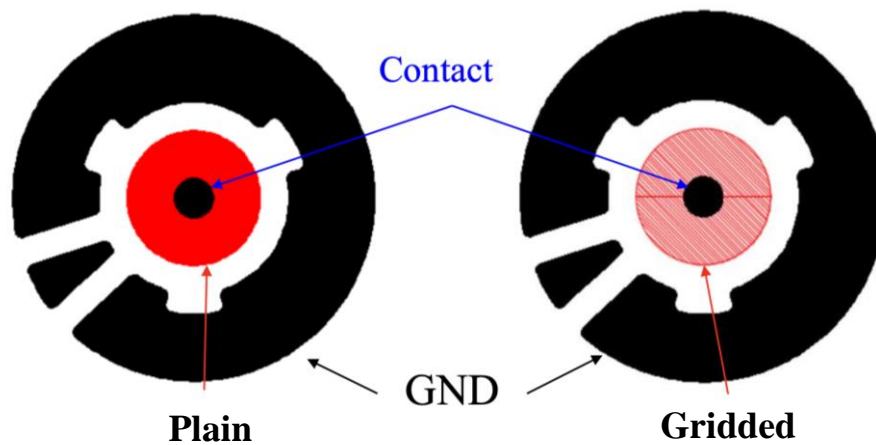
	μ RWELL5	μ RWELL1	μ RWELL9	μ RWELL13
Pitch (μm)	120	120	100	80
Hole(o) (μm)	100	100	80	60
Hole(i) (μm)	80	80	60	40
Hole shape	Round	Square	Round	round
Readout	Plain	Plain	Plain	Plain
Spacer (μm)	170	170	170	170
Photocathode	CsI	CsI	CsI	CsI

We also looked at the impact of the pad area on detector capacitance and timing resolution

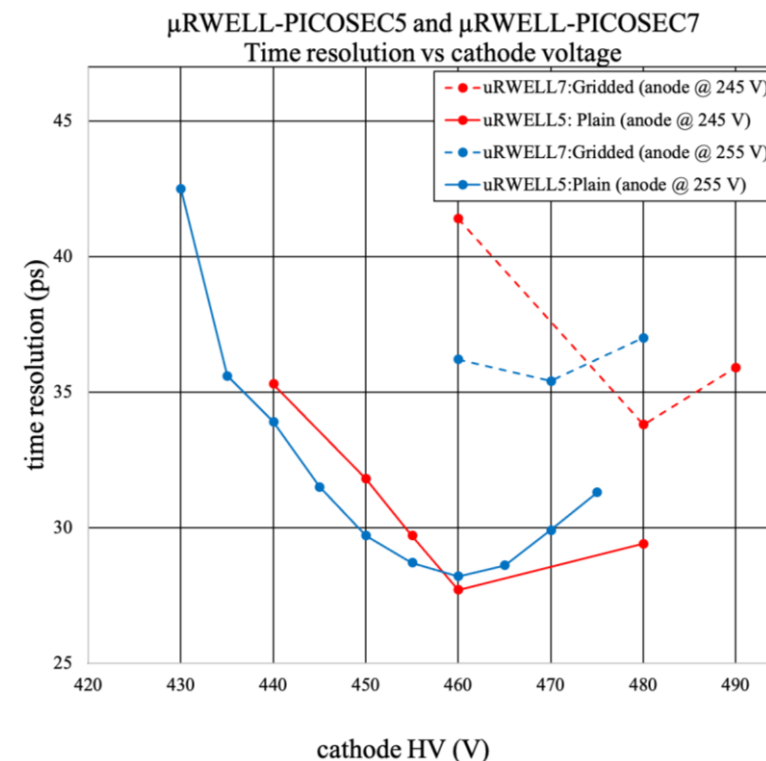
- ❖ Prototype featuring a plain readout demonstrates improved timing resolution compared to the prototype with a gridded readout scheme.

- ❖ This is mostly because the signal collection with the gridded pad readout is twice smaller → so we could expect some improvement with larger gain

Caveat: Different photocathode samples were used in different prototypes so the results might also be affected by the quality of the photocathod

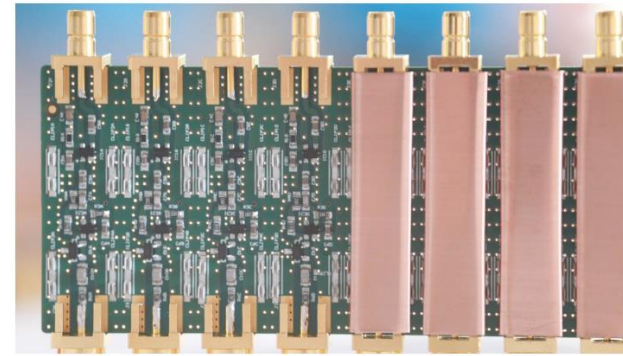


Parameters	μRWELL5	μRWELL7
Pitch (μm)	120	120
Hole(o) (μm)	100	100
Hole(i) (μm)	80	80
Hole shape	Round	Round
Readout	Plain	Gridded
Spacer (μm)	170	170
Photocathode	CsI	CsI

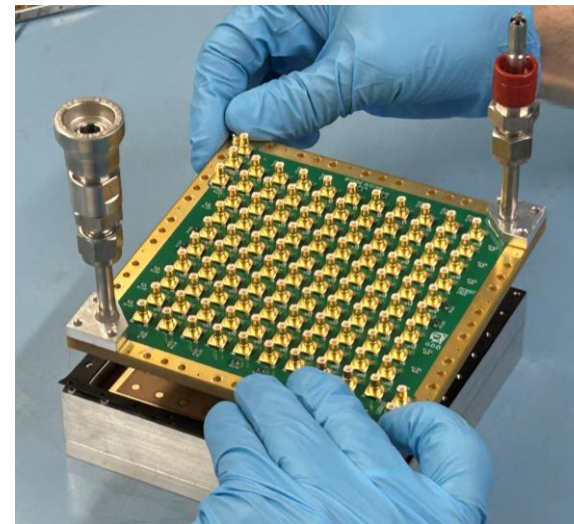


Large (10 cm×10 cm) μ RWELL-PICOSEC prototype 100-pads readout

- ❖ 100-pads μ RWELL-PICOSEC with **120 μ m** pitch, **100 μ m** outer diameter and **80 μ m** inner diameter assembled
- ❖ The back of the large μ RWELL-PCB connect to outer readout PCB through pogo pins
- ❖ Instrumented with fast electronics based on custom fast preamplifiers coupled with the multi channel SAMPIC digitizer readout & DAQ



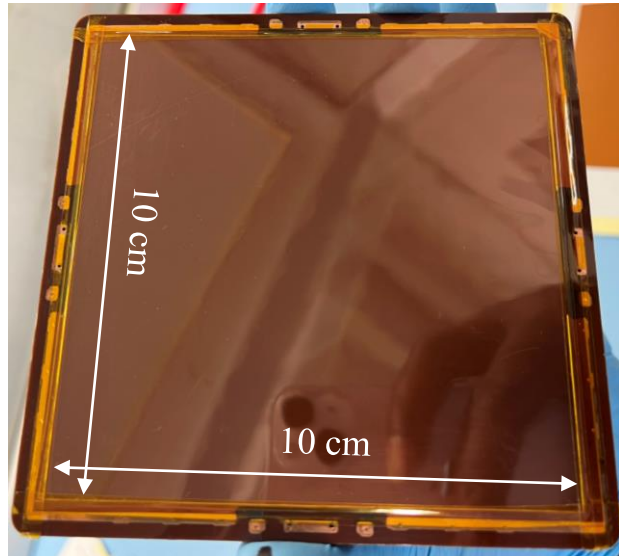
10-channel fast preamplifier card



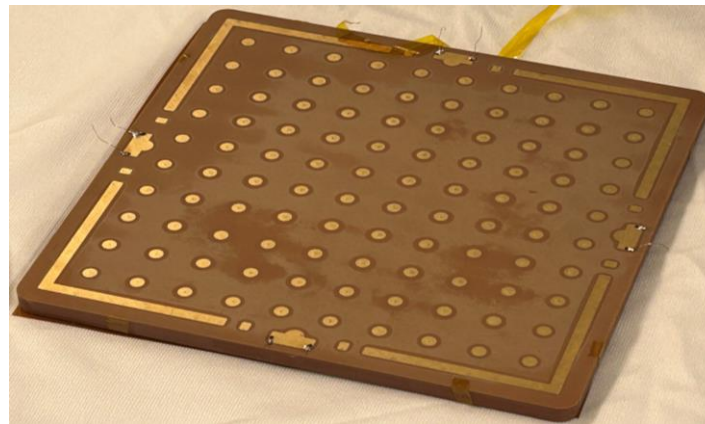
Prototype in Al housing, closed by outer readout PCB



64-channels SAMPIC

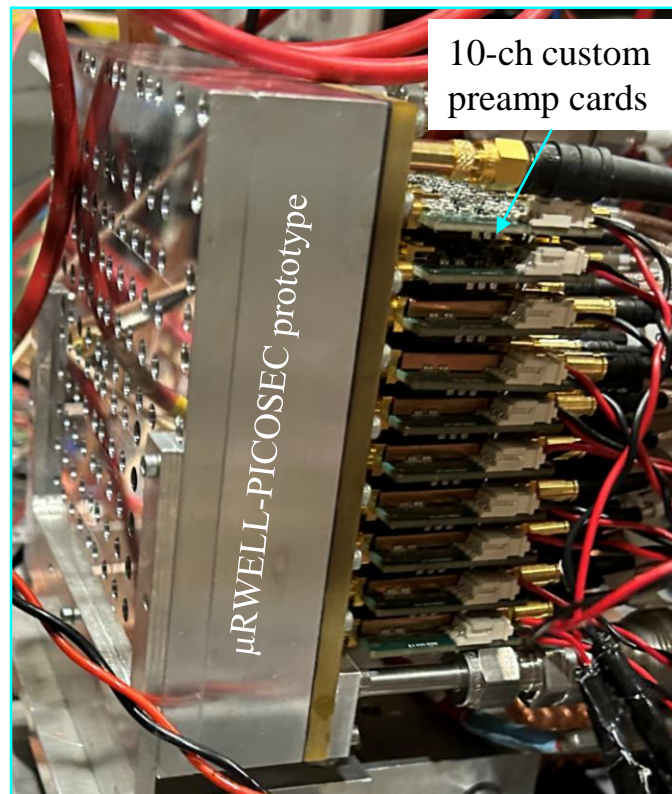
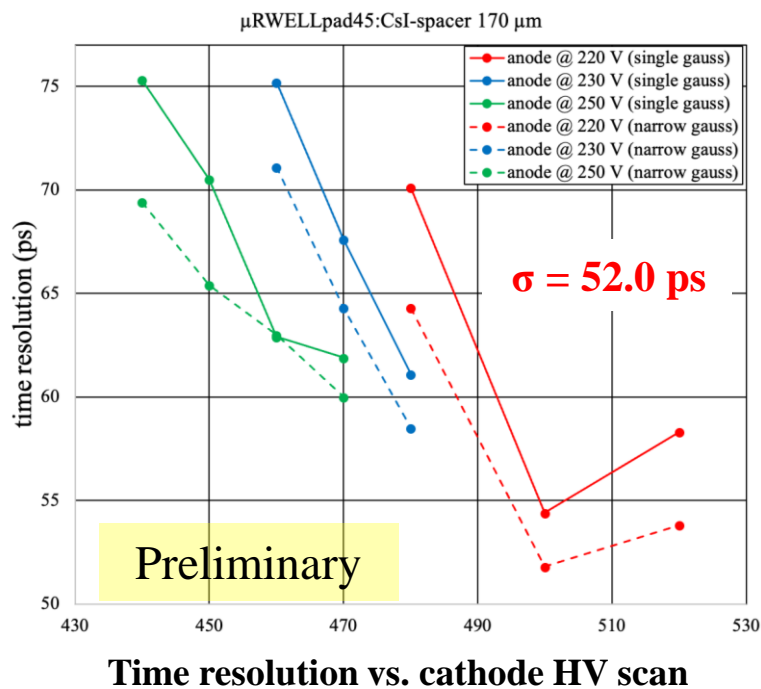


Top side of the μ RWELL-PCB

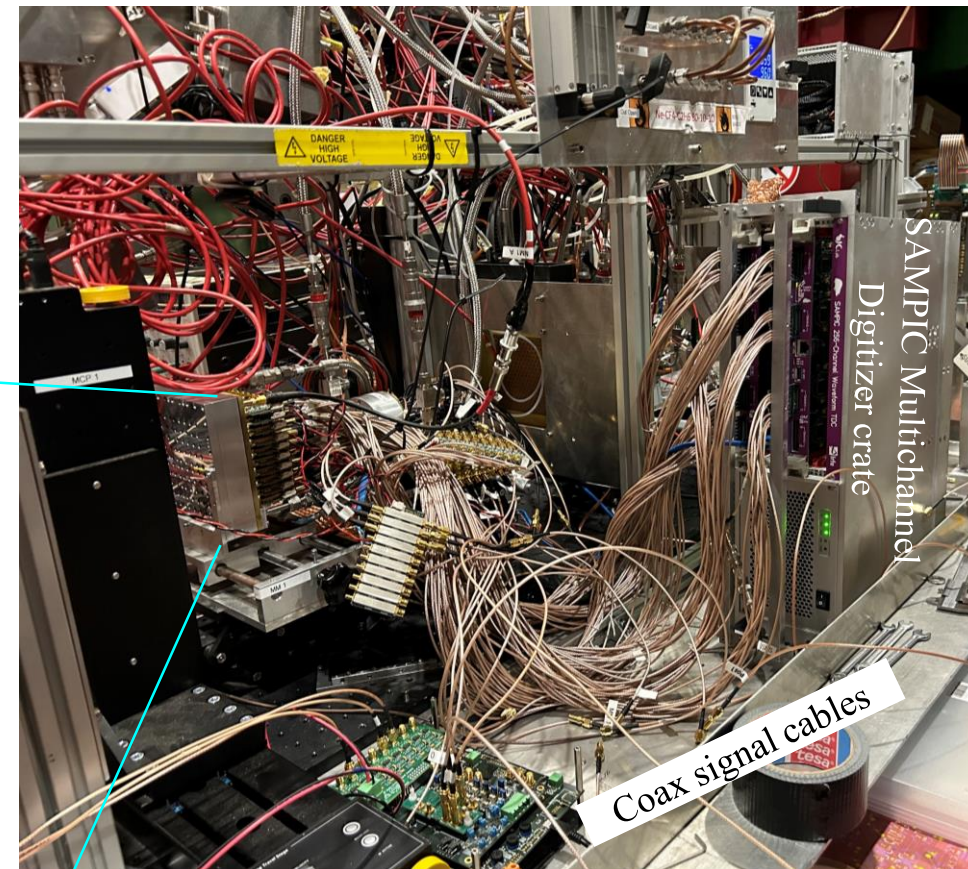


Back side of the μ RWELL PCB

- ❖ The large (10 cm × 10 cm) μ RWELL-PICOSEC tested in beam July 2024
- ❖ Runs with all 100 pads connected to custom preamp cards + SAMPIC digitizer
- ❖ **Position scan of full area (all 100 pads) → dedicated SAMPIC runs**
- ❖ HV scan on pad45 to determine optimal voltage setting
- ❖ Detector run flawlessly but planarity is poor → will affect timing performance



Zoomed view of large prototype



Large prototype in beam test setup at CERN (July 2024)

- ❖ preliminary test beam results on individual pads give time resolution ~ 52 ps → **Gap non uniformity and poor quality CsI photocathode**
- ❖ Analysis is still ongoing

- ❖ Fast timing μ RWELL-PICOSEC technology with picosecond timing resolution is fast emerging field for Time of Flight (TOF) PID applications in HEP and NP field.
- ❖ Preliminary beam test results with small μ RWELL-PICOSEC prototypes show timing resolution of 23 ps after optimization of μ RWELL PCB geometry and features.
- ❖ The results suggested that further optimization possible to reach < 20 ps resolution with MIPs.
- ❖ Large area $10\text{ cm} \times 10\text{ cm}$ μ RWELL-PICOSEC prototype was also successfully tested with encouraging results for large and cost effective fast timing detector technologies.
- ❖ We will explore funding opportunities to develop application as TOF PID options for future detector such as a potential EIC detector II or for future FCC detector.

This material is based upon work supported by the U.S. Department of Energy, Office of Science, Office of Nuclear Physics under contracts DE-AC05-06OR23177

The research described in these slides was conducted under the Laboratory Directed Research and Development (LDRD) Program at Thomas Jefferson National Accelerator Facility for the U.S. Department of Energy under contract DE-AC05-06OR23177.



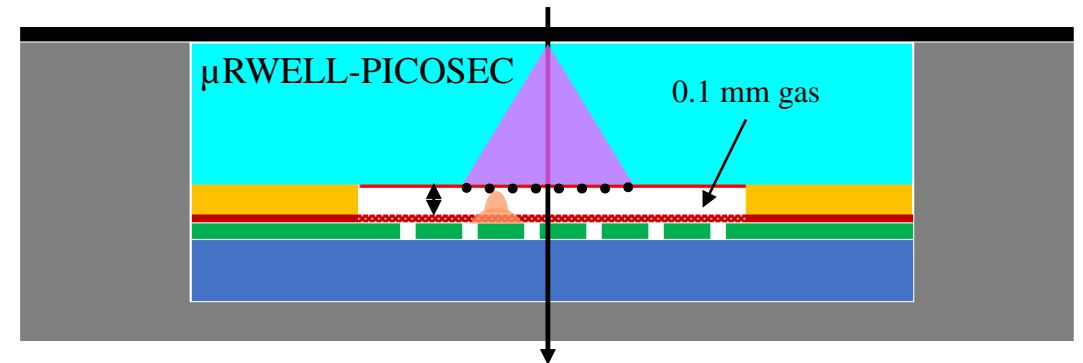
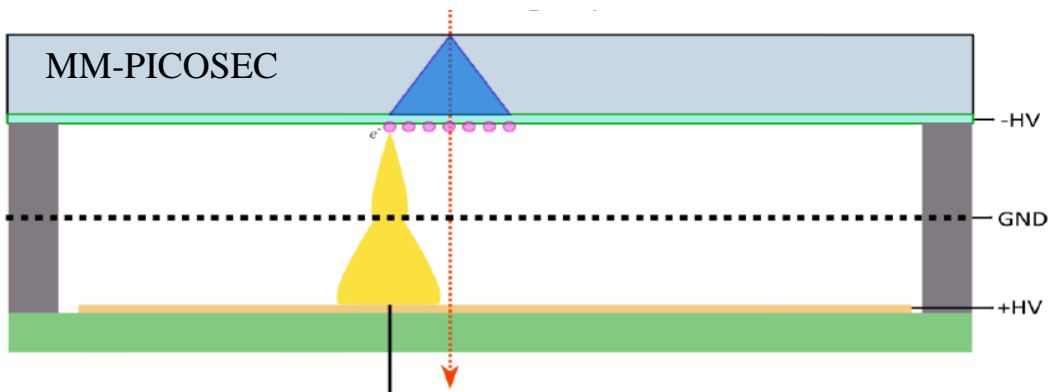
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Back-up

- ❖ μ RWELL-PICOSEC and MM-PICOSEC belongs to the MPGD-based fast timing detector family
- ❖ Difference in amplification structure allows different type of optimization of the technologies in term of operation stability and performance
- ❖ Parallel development of will mutually benefit the two technologies and offer options for applications

	MM-PICOSEC	μ RWELL-PICOSEC	Comments
Radiator & photocathode	Same for both devices		common R&D
Readout structure	Same for both devices		common R&D
Amplification structure	Metallic mesh 128 μ m \checkmark \rightarrow (low capacitance) but woven mesh \rightarrow non uniform gap \times	Standard μ RWELL foil has large capacitance \times	But lot of flexibility for optimization (thickness, pitch and hole geometry ...)
Resistive vs. metallic	Both options available \checkmark	Only resistive \checkmark	Resistive \rightarrow HV stability
Mechanical structure	Mesh tensioning challenging for large area	no pillar, no stretching \checkmark	
Segmentation MPGD	Segmentation of the mesh will be challenging	μ RWELL Cu-electrode can be segmented \checkmark	Improve rate capabilities for resistive



Timing detector for relativistic charged particles:

- ❖ Cerenkov radiator crystal transparent in VUV region
- ❖ High quantum efficiency (QE) photocathode in VUV medium ~ 7 photoelectrons for 3 mm MgF2
- ❖ Goal for timing resolution (~ 25 ps)

Applications:

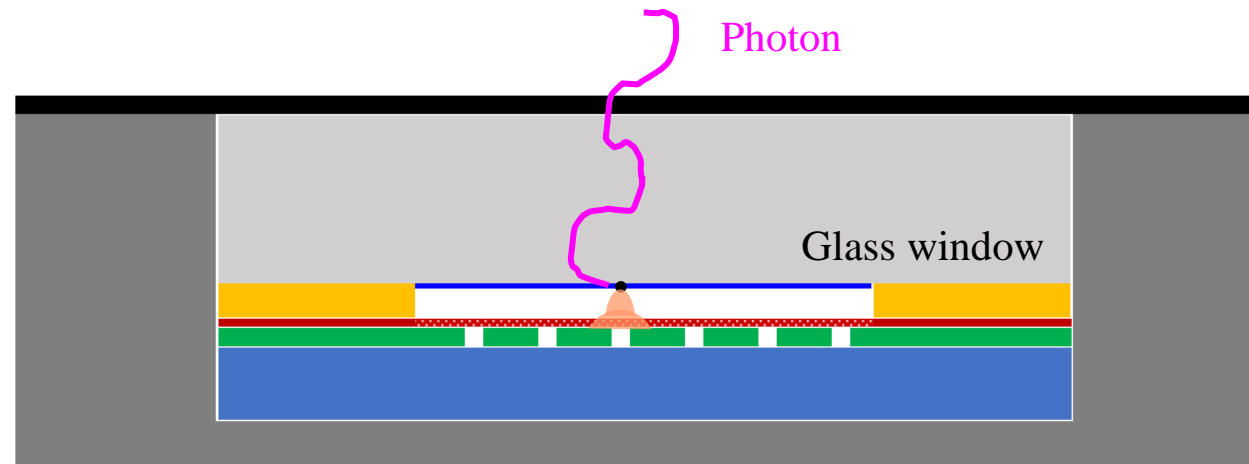
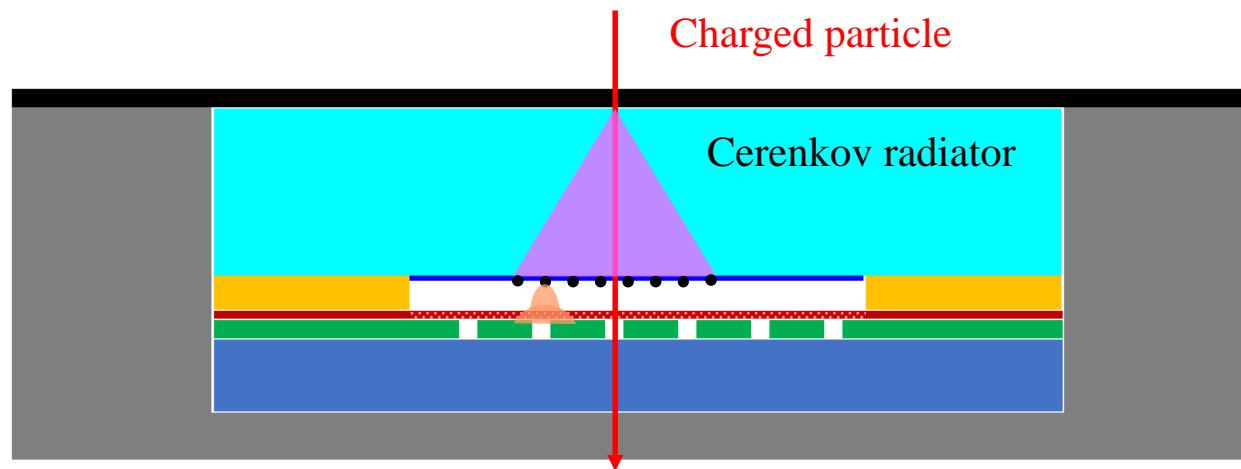
- ❖ Time of Flight detector
- ❖ T0 detector

Single photon photodetector:

- ❖ High quantum efficiency (QE) photocathode in (VUV) medium which is most radiated by any radiator medium
- ❖ Window transparent to Cerenkov radiation
- ❖ High gain for single photon timing goal of $\sim 50 - 70$ ps

Applications:

- ❖ Photosensor for RICH detectors
- ❖ T0 tagger at neutrino detector (liquid Ar scintillator light)



This R&D target



This R&D target

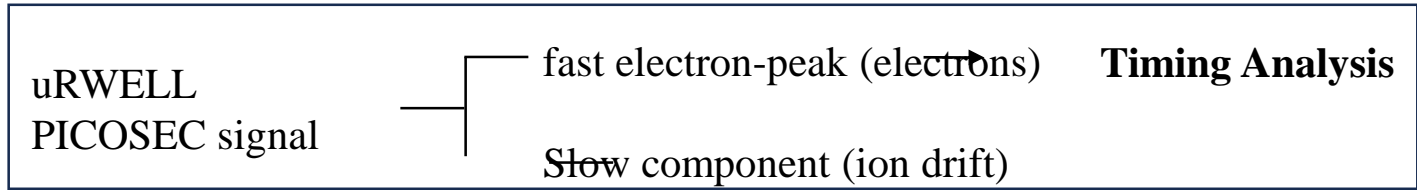


Time of Flight (TOF) detectors

	MRPCs	AC-LGAD	μrPICOSEC
Time resolution (ps)	20 – 70 ✓	20 ✓	25 ✓
Rate (MHz / cm ²)	0.05 ✗	N/A	> 1 ✓
Position resolution (mm)	~ 10 ✗	0.030 ✓ (claim)	< 1mm ✓
Performance in high B-field	Yes	Yes	Yes ✓
module size	20 × 20 cm ² ✓	N/A	20 × 20 cm ² ✓
Cost (\$ M / m ²)	0.2 – 0.4 ✓	High ✗	0.2 – 0.4? ✓

Photosensors for Cerenkov detectors

	SiPMs	MCP-PMTs	LAPPDs	μrPICOSEC
Time resolution (ps)	< 100	< 100	50 ✓	50 ✓
Position resolution (mm)	> 1 ✗	1 ✗	0.3 – 1 ✓	< 1 ✓
Performance in high B-field	Yes	Limited	Limited	Yes ✓
Radiation hardness	dark current ✗	N/A	N/A	Yes ✓
Cost (\$ M / m ²)	0.8 – 1 ✗	> 1 ✗	0.8 – 1 ✗	0.2 – 0.4 ✓



Electron peak: the difference between the highest point of the waveform and the baseline

For the timing measurement, a **Constant Fraction** (CF) method based on a sigmoid function is used to minimize the contribution of the noise

A sigmoid function is fit to the leading edge of the electron-peak:

$$V(t) = \frac{P_0}{1 + \exp(-P_2 \times (t - P_1))} + P_3$$

where P_0 and P_3 respectively the maximum and the minimum values, P_1 is the inflection time (i.e. where the slope changes derivative), and P_2 quantifies the speed of the sigmoid change (i.e. is correlated to the signal risetime).

The time corresponding to a 20% CF is calculated as follows:

$$t_z = P_1 - \frac{1}{P_2} \log \left[\frac{P_0}{0.2 \times V_{\max} - P_3} - 1 \right]$$

Now above time is calculated for both uRWELL and MCP PMT and then difference of them gives time resolution.

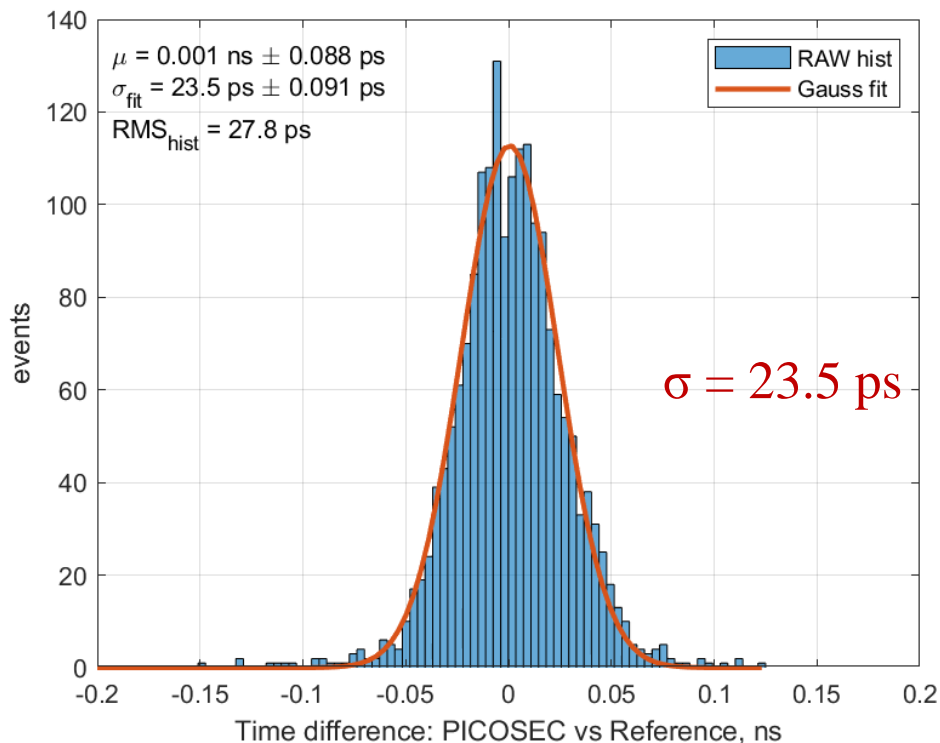
Cuts used to obtained final time difference distribution:

1. Time window cut applied to select events within pm300 ps of the median time difference of all triggered events.
2. Min and maximum signal amplitude cut
3. Geometrical cut: central pad only (to avoid partial loss of photoelectrons outside center pad region)

J. Bortfeldt, F. Brunbauer, C. David, D. Desforge, et al. NIM A 903 (2018) 317–325. doi:<https://doi.org/10.1016/j.nima.2018.04.033>.

CsI photocathode

- ❖ Npe ~7 → excellent timing resolution ✓
- ❖ Handling in vacuum ✗
- ❖ Hygroscopic ✗
- ❖ Ion bombardment ✗
- ❖ High rate limitation ✗



DLC photocathode

- ❖ Npe ~2-3 → worse timing resolution ✗
- ❖ Very stable material ✓
- ❖ No hygroscopic ✓
- ❖ Ion bombardment ✓
- ❖ High rate ✓

